MOSFET – N-Channel, SUPERFET[®] II

600 V, 47 A, 70 m Ω

FCH47N60

Description

SuperFET II MOSFET is ON Semiconductor's first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low onresistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.

Features

- Typ. $R_{DS(on)} = 58 \text{ m}\Omega$
- 650 V @ $T_J = 150^{\circ}C$
- Ultra Low Gate Charge (Typ. Q_g = 210 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 420 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Applications

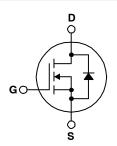
- Telecom / Sever Power Supplies
- Industrial Power Supplies



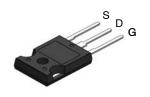
ON Semiconductor®

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V _{DS}	R _{DS(ON)} MAX	I _D MAX		
600 V	70 mΩ @ 10 V	47 A		

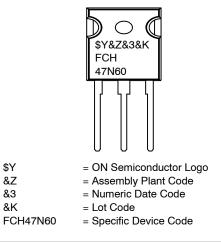


N-CHANNEL MOSFET



TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	FCH47N60	Unit	
V _{DSS}	Drain to Source Voltage		600	V
V _{GSS}	Gate to Source Voltage		±30	
Ι _D	Drain Current:	– Continuous (T _C = 25°C)	47	Α
		– Continuous (T _C = 100°C)	29.7	
I _{DM}	Drain Current:	– Pulsed (Note 1)	141	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		1800	mJ
I _{AR}	Avalanche Current (Note 1)		47	A
E _{AR}	Repetitive Avalanche Energy (Note 1)		41.7	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5	V/ns
P _D	Power Dissipation	(T _C = 25°C)	417	W
		– Derate Above 25°C	3.33	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		–55 to + 150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

ABSOLUTE MAXIMUM RATINGS (T_C = 25° C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 18 \text{ A}, V_{DD} = 50 \text{ V}, R_G = 25 \Omega$, Starting $T_J = 25 \text{ °C}$. 3. $I_{SD} \leq 48 \text{ A}, \text{ di/dt} \leq 200 \text{ A/}\mu\text{s}, V_{DD} \leq \text{BV}_{DSS}$, Starting $T_J = 25 \text{ °C}$.

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH47N60_F133	FCH47N60	TO-247	Tube	N/A	N/A	30 Units

THERMAL CHARACTERISTICS

Symbol	Parameter	FCH47N60	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Case-to-Sink, Typ.	0.24	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	41.7	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
OFF CHAR	ACTERISTICS					
BV _{DSS} Drain to Source	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 $\mu A,T_C$ = 25°C	600	-	-	V
		V_{GS} = 0 V,I _D = 250 µA, T _C = 150°C	-	650	-	
$\Delta {\rm BV}_{\rm DSS}$ / $\Delta {\rm T}_{\rm J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$	-	0.6	-	V/°C
BV _{DS}	Drain to Source Avalanche Breadown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 47 \text{ A}$	-	700	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μA
		V_{DS} = 480 V, T_{C} = 125 °C	-	-	10	
I _{GSS}	Gate to Body Leakage Current	V_{GS} = ±30 V, V_{DS} = 0 V	-	-	±100	nA
ON CHARA	CTERISTICS	•				
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	3	-	5	V
R _{DS(on)}	Static Drain to Source On Resistance	V_{GS} = 10 V, I _D = 23.5 A	-	0.058	0.070	Ω
9 FS	Forward Transconductance	$V_{DS} = 40 \text{ V}, \text{ I}_{D} = 23.5 \text{ A}$	-	40	-	S
DYNAMIC C	HARACTERISTICS	•			•	
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz	-	5900	8000	pF
Coss	Output Capacitance		_	3200	4200	pF
C _{rss}	Reverse Transfer Capacitance		_	250	-	pF
C _{oss}	Output Capacitance	V_{DS} = 480 V, V_{GS} = 0 V, f = 1.0 MHz	-	160	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	-	420	-	pF
SWITCHING	CHARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 47 \text{ A},$	_	185	430	ns
t _r	Turn–On Rise Time	V _{GS} = 10 V, R _g = 25 Ω (Note 4)	-	210	450	ns
t _{d(off)}	Turn-Off Delay Time		_	520	1100	ns
t _f	Turn-Off Fall Time		-	75	160	ns
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 480 \text{ V}, \text{ I}_{D} = 47 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$ (Note 4)	-	210	270	nC
Q _{gs}	Gate to Source Gate Charge		_	38	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	7	_	110	-	nC
DRAIN-SOU	RCE DIODE CHARACTERISTICS	•			•	
I _S	Maximum Continuous Source to Drain Diode Forward Current			-	47	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	141	А
V _{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0 V, I_{SD} = 47 A$	-	-	1.4	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_{SD} = 47 A,$	-	590	-	ns
Q _{rr}	Reverse Recovery Charge	dl _F /dt = 100 Å/μs	_	25	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Essentially independent of operating temperature.

TYPICAL CHARACTERISTICS

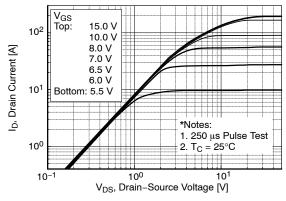


Figure 1. On–Region Characteristics

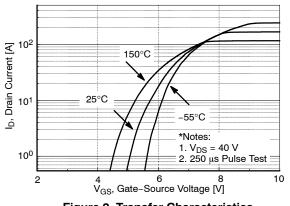


Figure 2. Transfer Characteristics

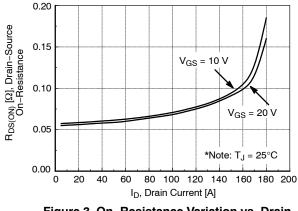


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

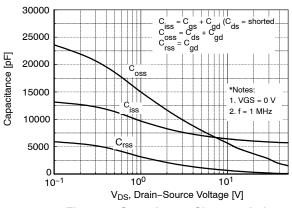


Figure 5. Capacitance Characteristics

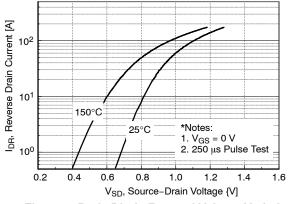
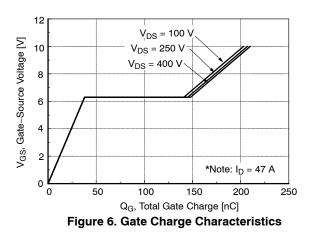
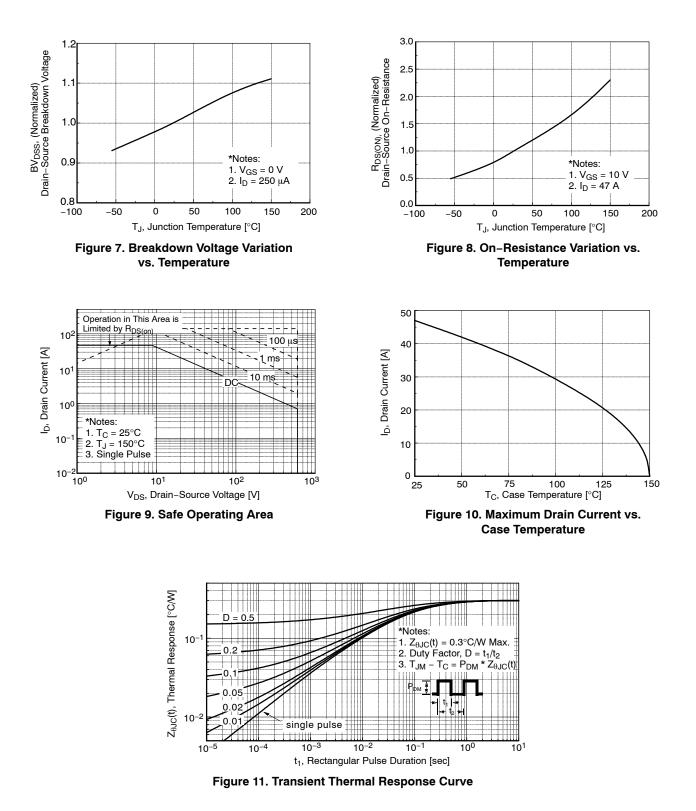
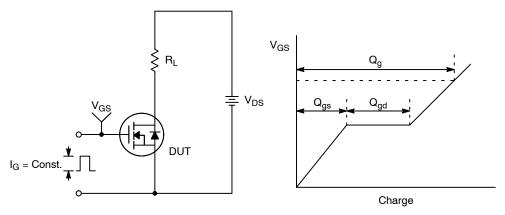


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature



TYPICAL CHARACTERISTICS







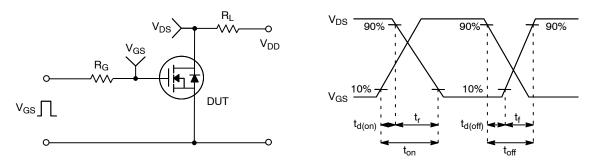


Figure 13. Resistive Switching Test Circuit & Waveforms

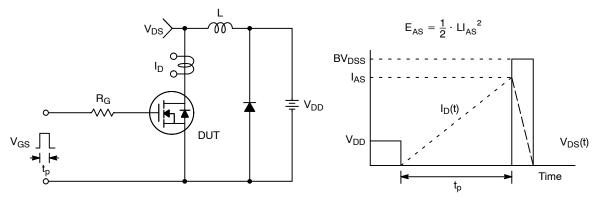


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

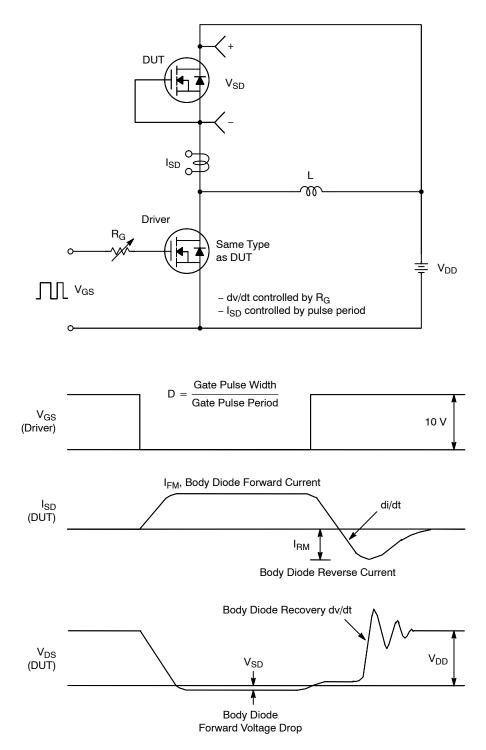


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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